ON Semiconductor

Is Now



To learn more about onsemi™, please visit our website at www.onsemi.com

onsemi and ONSEMI. and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. onsemi reserves the right to make changes at any time to any products or information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/ or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use onsemi products for any such unintended or unauthorized application,

NST3904DP6T5G

Dual General Purpose Transistor

The NST3904DP6T5G device is a spin-off of our popular SOT-23/SOT-323/SOT-563 three-leaded device. It is designed for general purpose amplifier applications and is housed in the SOT-963 six-leaded surface mount package. By putting two discrete devices in one package, this device is ideal for low-power surface mount applications where board space is at a premium.

Features

- h_{FE}, 100-300
- Low $V_{CE(sat)}$, $\leq 0.4 \text{ V}$
- Reduces Board Space and Component Count
- NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free and are RoHS Compliant

MAXIMUM RATINGS

Rating		Symbol	Value	Unit
Collector - Emitter Voltage		V_{CEO}	40	Vdc
Collector - Base Voltage		V _{CBO}	60	Vdc
Emitter - Base Voltage		V _{EBO}	6.0	Vdc
Collector Current - Continuous		I _C	200	mAdc
Electrostatic Discharge	HBM MM	ESD Class	2 B	

THERMAL CHARACTERISTICS

Characteristic (Single Heated)	Symbol	Max	Unit
Total Device Dissipation T _A = 25°C Derate above 25°C (Note 1)	P _D	240 1.9	mW mW/°C
Thermal Resistance, Junction-to-Ambient (Note 1)	$R_{\theta JA}$	520	°C/W
Total Device Dissipation T _A = 25°C Derate above 25°C (Note 2)	P _D	280 2.2	mW mW/°C
Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{ heta JA}$	446	°C/W
Characteristic (Dual Heated) (Note 3)	Symbol	Max	Unit
Total Device Dissipation T _A = 25°C Derate above 25°C (Note 1)	P _D	350 2.8	mW mW/°C
Thermal Resistance, Junction-to-Ambient (Note 1)	$R_{\theta JA}$	357	°C/W
Total Device Dissipation T _A = 25°C Derate above 25°C (Note 2)	P _D	420 3.4	mW mW/°C
Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{\theta JA}$	297	°C/W
Junction and Storage Temperature Range	T _J , T _{stg}	–55 to +150	°C

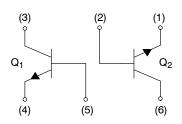
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. FR-4 @ 100 mm², 1 oz. copper traces, still air. 2. FR-4 @ 500 mm², 1 oz. copper traces, still air.
- 3. Dual heated values assume total power is sum of two equally powered channels.



ON Semiconductor®

www.onsemi.com



NST3904DP6T5G



SOT-963 CASE 527AD

MARKING DIAGRAM



= Device Code = Date Code

ORDERING INFORMATION

Device	Package	Shipping [†]
NST3904DP6T5G	SOT-963 (Pb-Free)	8000/Tape & Reel
NSVT3904DP6T5G	SOT-963 (Pb-Free)	8000/Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

NST3904DP6T5G

ELECTRICAL CHARACTERISTICS ($T_A = 25$ °C unless otherwise noted)

	haracteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS		•	•	•	•
Collector - Emitter Breakdown Volta	age (Note 4) (I _C = 1.0 mAdc, I _B = 0)	V _{(BR)CEO}	40	-	Vdc
Collector - Base Breakdown Voltage	e (I _C = 10 μAdc, I _E = 0)	V _{(BR)CBO}	60	-	Vdc
Emitter - Base Breakdown Voltage ($(I_E = 10 \mu Adc, I_C = 0)$	V _{(BR)EBO}	6.0	-	Vdc
Collector Cutoff Current (V _{CE} = 30 \	I _{CEX}	-	50	nAdc	
ON CHARACTERISTICS (Note 4)				•	
$\begin{array}{l} \text{DC Current Gain} \\ \text{(I}_{\text{C}} = 0.1 \text{ mAdc, V}_{\text{CE}} = 1.0 \text{ Vdc)} \\ \text{(I}_{\text{C}} = 1.0 \text{ mAdc, V}_{\text{CE}} = 1.0 \text{ Vdc)} \\ \text{(I}_{\text{C}} = 10 \text{ mAdc, V}_{\text{CE}} = 1.0 \text{ Vdc)} \\ \text{(I}_{\text{C}} = 50 \text{ mAdc, V}_{\text{CE}} = 1.0 \text{ Vdc)} \\ \text{(I}_{\text{C}} = 100 \text{ mAdc, V}_{\text{CE}} = 1.0 \text{ Vdc)} \end{array}$		h _{FE}	40 70 100 60 30	- 300 - -	-
Collector – Emitter Saturation Voltage ($I_C = 10 \text{ mAdc}$, $I_B = 1.0 \text{ mAdc}$) ($I_C = 50 \text{ mAdc}$, $I_B = 5.0 \text{ mAdc}$)	ge	V _{CE(sat)}	- -	0.2 0.3	Vdc
Base – Emitter Saturation Voltage (I _C = 10 mAdc, I _B = 1.0 mAdc) (I _C = 50 mAdc, I _B = 5.0 mAdc)		V _{BE(sat)}	0.65 -	0.85 0.95	Vdc
SMALL-SIGNAL CHARACTERIST	TICS		•	•	•
Current - Gain - Bandwidth Product	t (I _C = 10 mAdc, V _{CE} = 20 Vdc, f = 100 MHz)	f _T	200	-	MHz
Output Capacitance (V _{CB} = 5.0 Vdc, I _E = 0, f = 1.0 MHz)		C _{obo}	-	4.0	pF
Input Capacitance (V _{EB} = 0.5 Vdc, I _C = 0, f = 1.0 MHz)		C _{ibo}	-	8.0	pF
Noise Figure (V_{CE} = 5.0 Vdc, I_{C} = 100 μ Adc, R_{S} = 1.0 k Ω , f = 1.0 kHz)		NF	-	5.0	dB
SWITCHING CHARACTERISTICS					•
Delay Time ((V _{CC} = 3.0 Vdc, V _{BE} = -0.5 Vdc)	t _d	-	35	
Rise Time ((I _C = 10 mAdc, I _{B1} = 1.0 mAdc)	t _r	-	35	ns
Storage Time ((V _{CC} = 3.0 Vdc, I _C = 10 mAdc)	t _s	-	275	
Fall Time ($(I_{B1} = I_{B2} = 1.0 \text{ mAdc})$	t _f	-	50	ns

^{4.} Pulse Test: Pulse Width \leq 300 μ s; Duty Cycle \leq 2.0%.

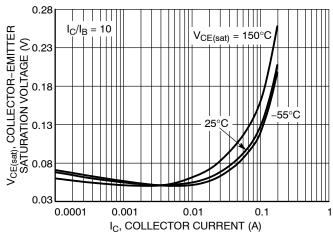


Figure 1. Collector Emitter Saturation Voltage vs.
Collector Current

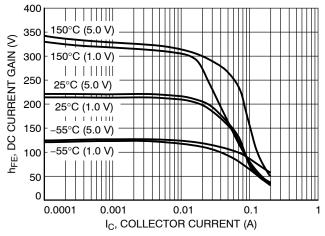


Figure 2. DC Current Gain vs. Collector Current

NST3904DP6T5G

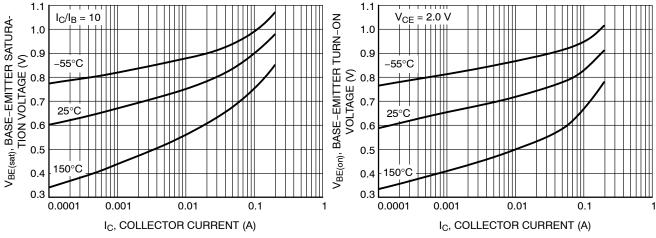


Figure 3. Base Emitter Saturation Voltage vs. Collector Current

Figure 4. Base Emitter Turn-On Voltage vs.
Collector Current

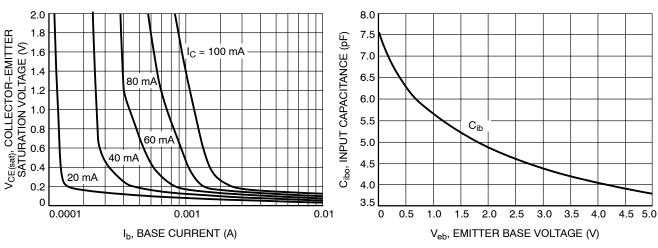


Figure 5. Saturation Region

Figure 6. Input Capacitance

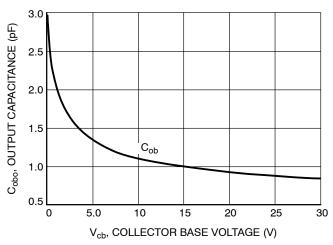


Figure 7. Output Capacitance

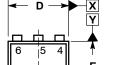
MECHANICAL CASE OUTLINE



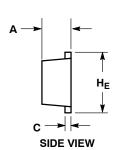


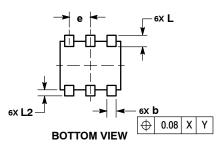
SOT-963 CASE 527AD-01 **ISSUE E**

DATE 09 FEB 2010



TOP VIEW





STYLE 1: PIN 1. EMITTER 1 2. BASE 1

COLLECTOR 2 EMITTER 2 BASE 2

6. COLLECTOR 1

STYLE 4: PIN 1. COLLECTOR 2. COLLECTOR

3. BASE 4. EMITTER

5. COLLECTOR 6. COLLECTOR

STYLE 7: PIN 1. CATHODE 2. ANODE 3. CATHODE 4. CATHODE

ANODE 6. CATHODE

STYLE 10: PIN 1. CATHODE 1

2. N/C 3. CATHODE 2

 4. ANODE 2
 5. N/C 6. ANODE 1

STYLE 2:

PIN 1. EMITTER 1 2. EMITTER2

3. BASE 2 COLLECTOR 2 BASE 1

6. COLLECTOR 1 STYLE 5:

PIN 1. CATHODE 2. CATHODE 3. ANODE 4. ANODE 5. CATHODE 6. CATHODE

STYLE 8: PIN 1. DRAIN 2. DRAIN

3. GATE 4. SOURCE 5. DRAIN 6. DRAIN

STYLE 3:

PIN 1. CATHODE 1 2. CATHODE 1 3. ANODE/ANODE 2

4. CATHODE 2 5. CATHODE 2

6. ANODE/ANODE 1 STYLE 6:

PIN 1. CATHODE 2. ANODE

3. CATHODE 4. CATHODE 5. CATHODE 6. CATHODE

STYLE 9: PIN 1. SOURCE 1 2. GATE 1

3. DRAIN 2 4. SOURCE 2 5. GATE 2 6. DRAIN 1

NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- CONTROLLING DIMENSION: MILLIMETERS 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL
- 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

	MILLIMETERS			
DIM	MIN	NOM	MAX	
Α	0.34	0.37	0.40	
b	0.10	0.15	0.20	
С	0.07	0.12	0.17	
D	0.95	1.00	1.05	
Е	0.75	0.80	0.85	
е	0.35 BSC			
HE	0.95	1.00	1.05	
Ĺ	0.19 REF			
L2	0.05	0.10	0.15	

GENERIC MARKING DIAGRAM*



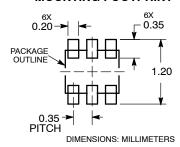
= Specific Device Code

М = Month Code

*This information is generic. Please refer to device data sheet for actual part marking.

Pb-Free indicator, "G" or microdot " ■", may or may not be present.

RECOMMENDED MOUNTING FOOTPRINT



ŀ	DOCUMENT NUMBER:	98AON26456D	Electronic versions are uncontrolled except when accessed directly from Printed versions are uncontrolled except when stamped "CONTROLLED"	
	DESCRIPTION:	SOT-963, 1X1, 0.35P		PAGE 1 OF 1

ON Semiconductor and un are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

ON Semiconductor and ware trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor and seven any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:
Email Requests to: orderlit@onsemi.com

ON Semiconductor Website: www.onsemi.com

TECHNICAL SUPPORT
North American Technical Support:
Voice Mail: 1 800-282-9855 Toll Free USA/Canada

Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support:

Phone: 00421 33 790 2910

For additional information, please contact your local Sales Representative

 \Diamond